

**RESPONSE UNDER 37 C.F.R. § 1.116**

**EXPEDITED PROCEDURE – Art Unit 2814**

Attorney Docket No. 108298742US

Disclosure No. 03-0599.00/US

**PATENT**



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF: SIDNEY B. RIGG *ET AL.*

APPLICATION NO.: 10/713,878

FILED: NOVEMBER 13, 2003

FOR: **MICROELECTRONIC DEVICES,  
METHODS FOR FORMING VIAS IN  
MICROELECTRONIC DEVICES, AND  
METHODS FOR PACKAGING  
MICROELECTRONIC DEVICES**

EXAMINER: HOWARD WEISS

ART UNIT: 2814

CONF. NO: 1111

**Amendment Under 37 C.F.R. § 1.116**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

The present communication responds to the Office Action dated December 16, 2005 in the above-identified application. Please amend the application as follows:

Amendments to the Specification begin on page 2.

Amendments to the Claims are reflected in the listing of claims beginning on page 3.